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(12) **United States Design Patent**
Ham

(10) **Patent No.:** **US D512,984 S**

(45) **Date of Patent:** **** Dec. 20, 2005**

(54) **EARLOOP FOR COMMUNICATIONS HEADSET**

D474,178 S * 5/2003 Eroma D14/223
D498,227 S * 11/2004 Dyer et al. D14/205

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* cited by examiner

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(**) Term: **14 Years**

(57) **CLAIM**

(21) Appl. No.: **29/229,738**

The ornamental design for a earloop for communications headset, as shown and described.

(22) Filed: **May 10, 2005**

DESCRIPTION

Related U.S. Application Data

(63) Continuation of application No. 29/212,885, filed on Sep. 8, 2004.

FIG. 1 is an upper front left perspective view of a earloop for communications headset having a microphone boom and an earloop, the communications headset being configured to be worn on a left ear of a user, the broken line drawings of the microphone boom of the communications headset in the drawings herein is for illustrative purposes only and forms no part of the claimed design.

(51) **LOC (6) Cl.** **14-01**

(52) **U.S. Cl.** **D14/205**

(58) **Field of Search** D14/205, 206,
D14/223, 225; 181/129, 130; 379/430,
433; 381/381, 370, 376, 377, 378, 379,
380; D24/174

FIG. 2 is a bottom plan view of the earloop for communications headset of FIG. 1.

FIG. 3 is a top plan view of the earloop for communications headset of FIG. 1.

(56) **References Cited**

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D469,422 S * 1/2003 Nguyen et al. D14/205

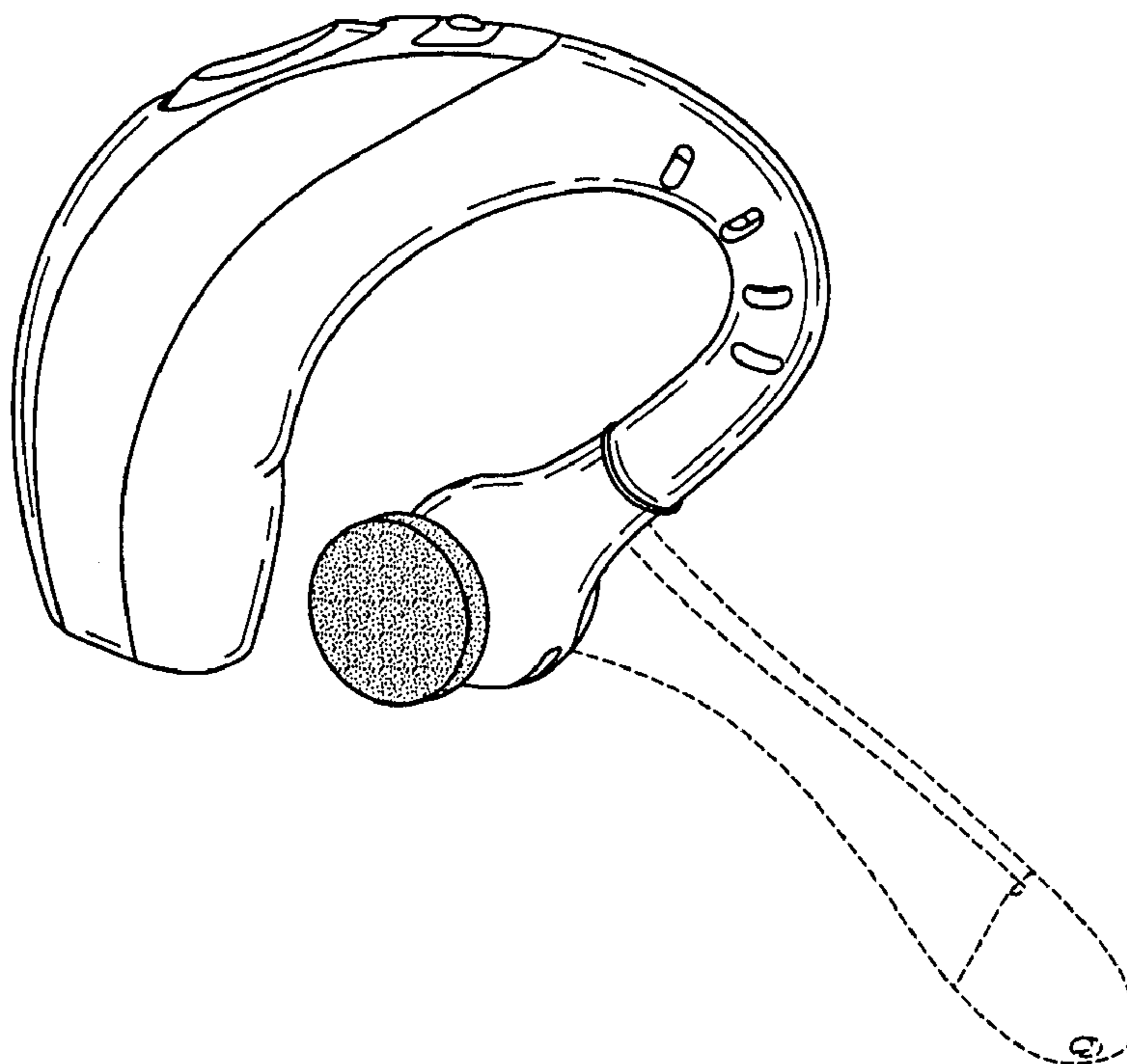
FIG. 4 is a left side elevational view of the earloop for communications headset of FIG. 1.

FIG. 5 is a right side elevational view of the earloop for communications headset of FIG. 1.

FIG. 6 is a front elevational view of the earloop for communications headset of FIG. 1; and,

FIG. 7 is a rear elevational view of the earloop for communications headset of FIG. 1.

1 Claim, 4 Drawing Sheets



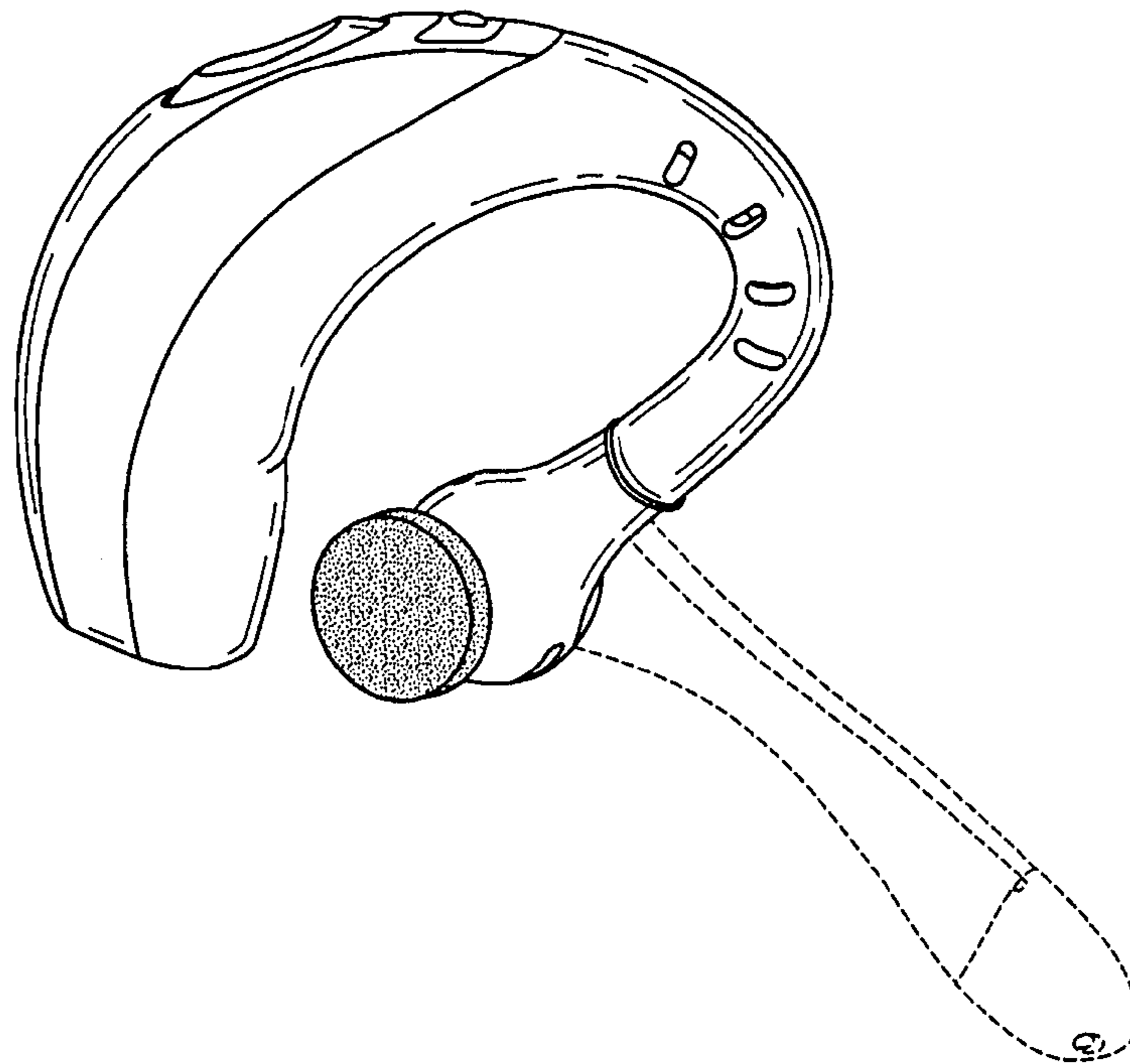


FIG. 1

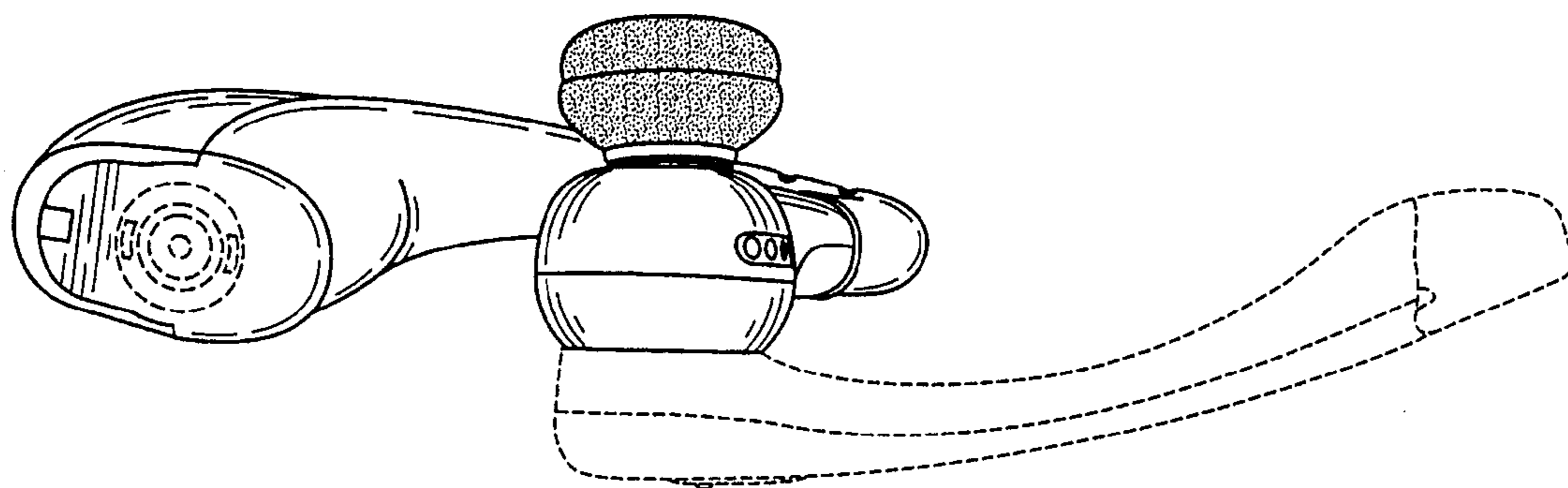


FIG. 2

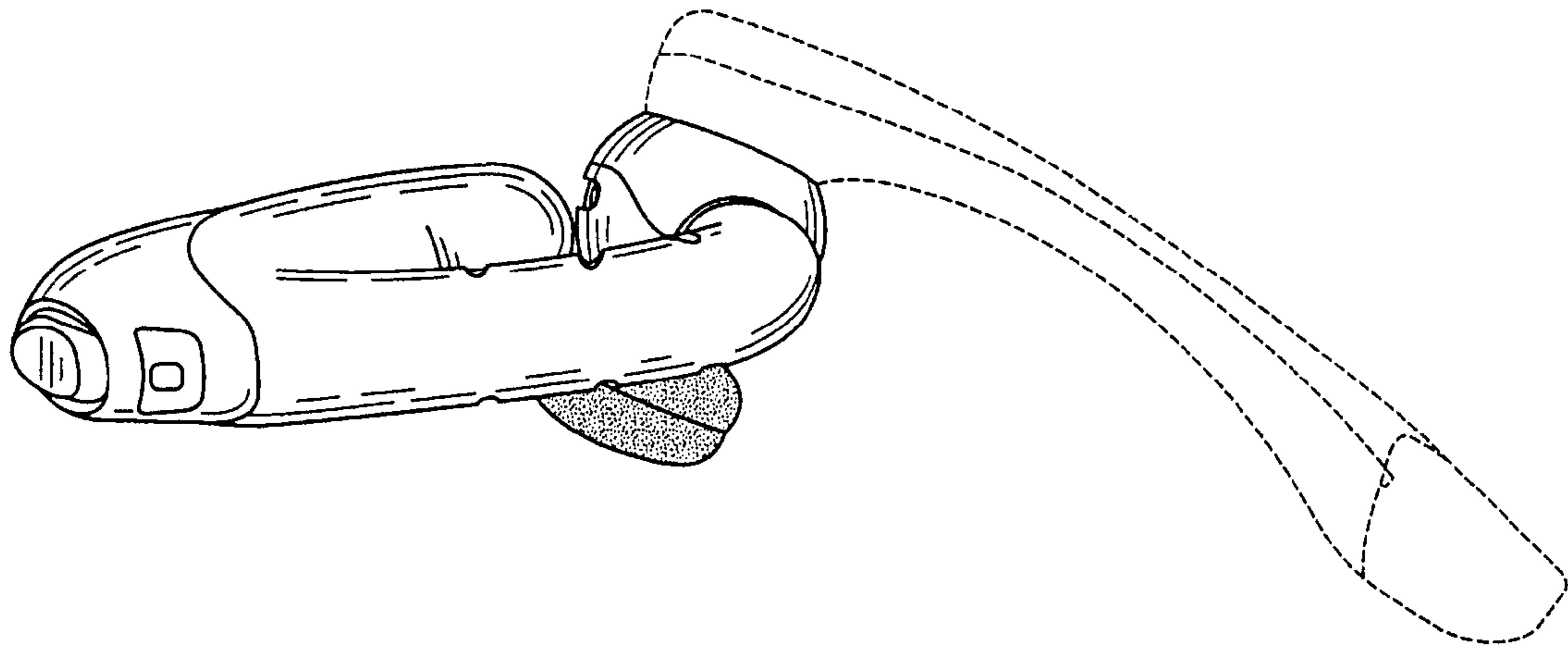


FIG. 3

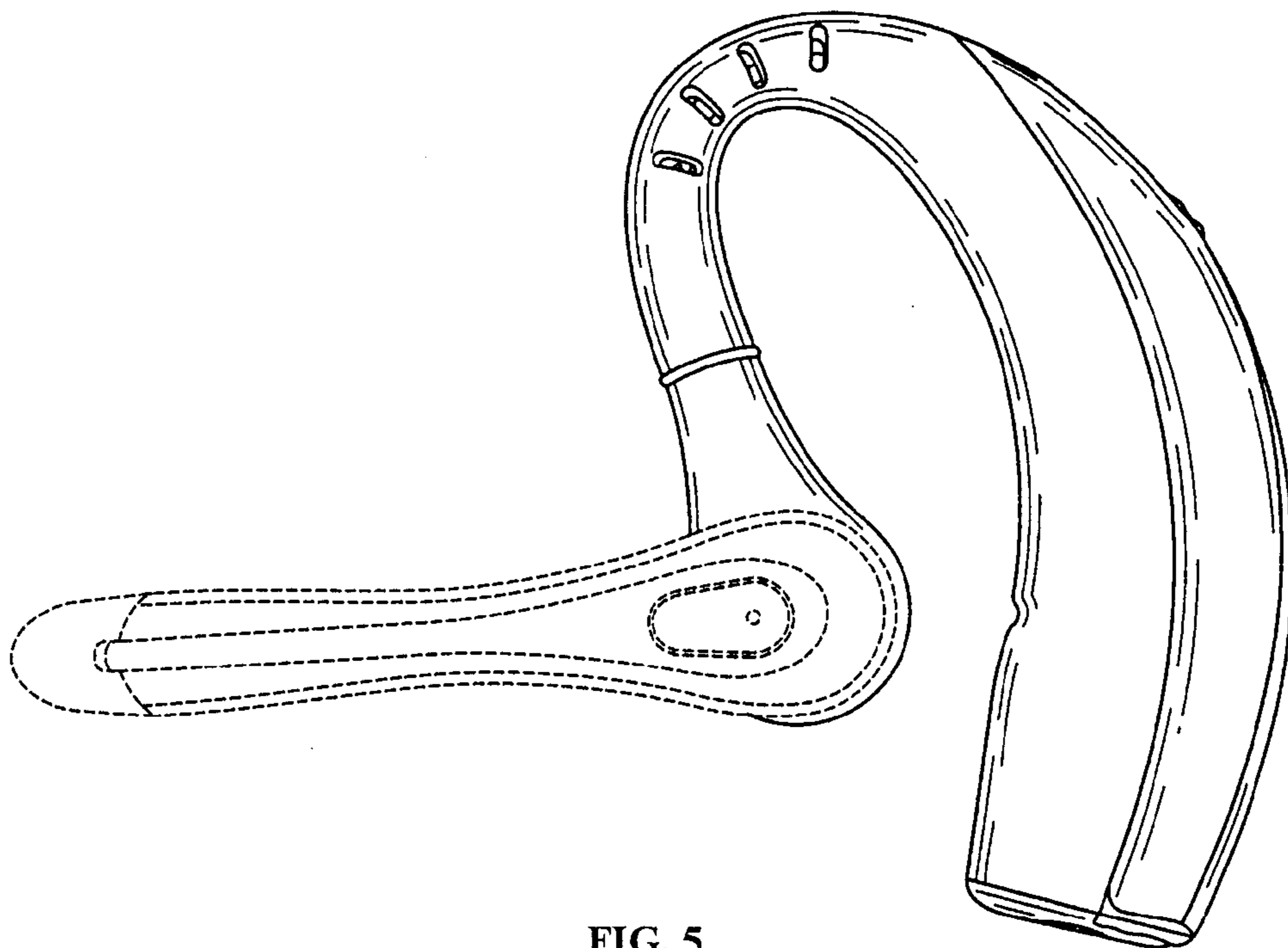


FIG. 5

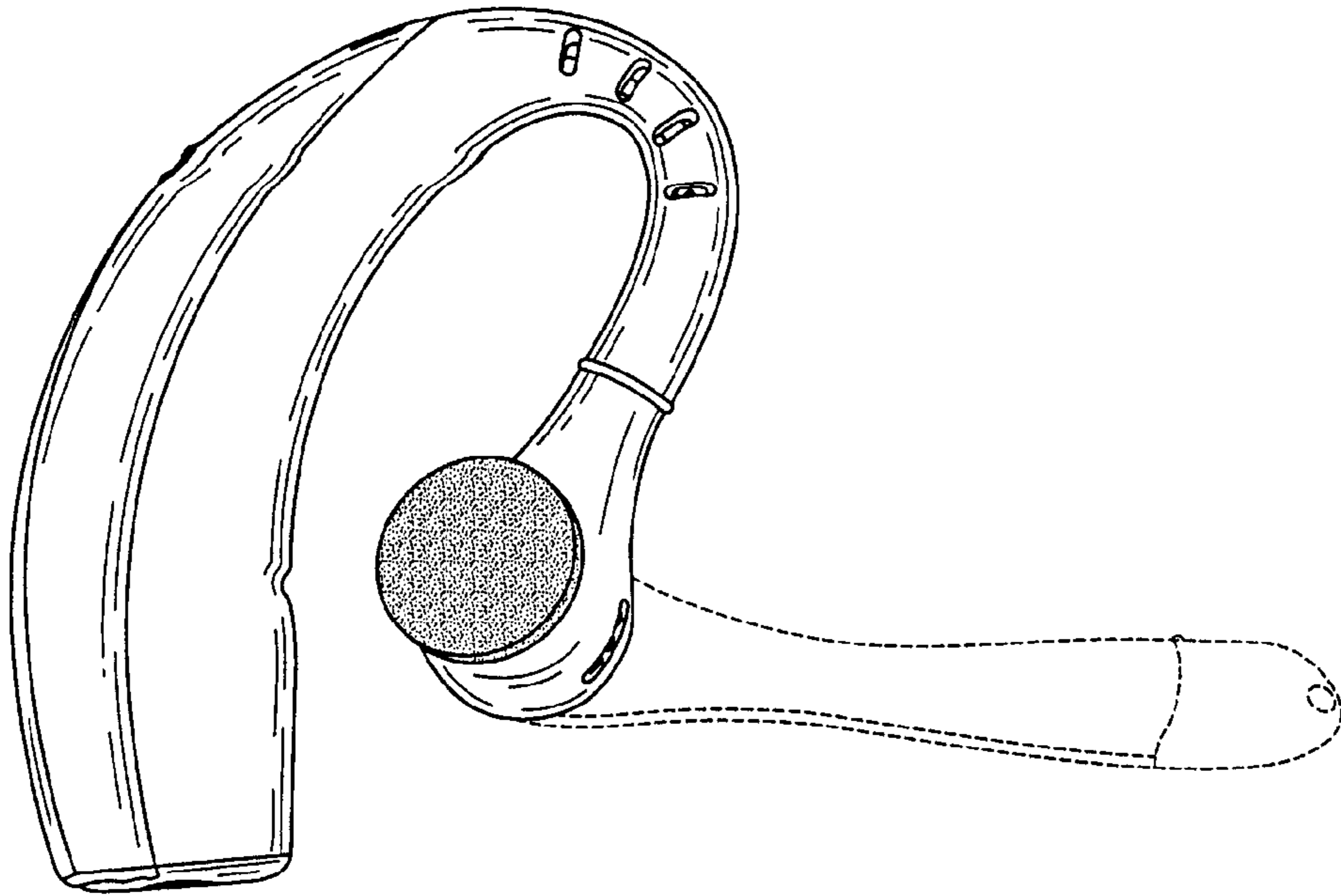


FIG. 4

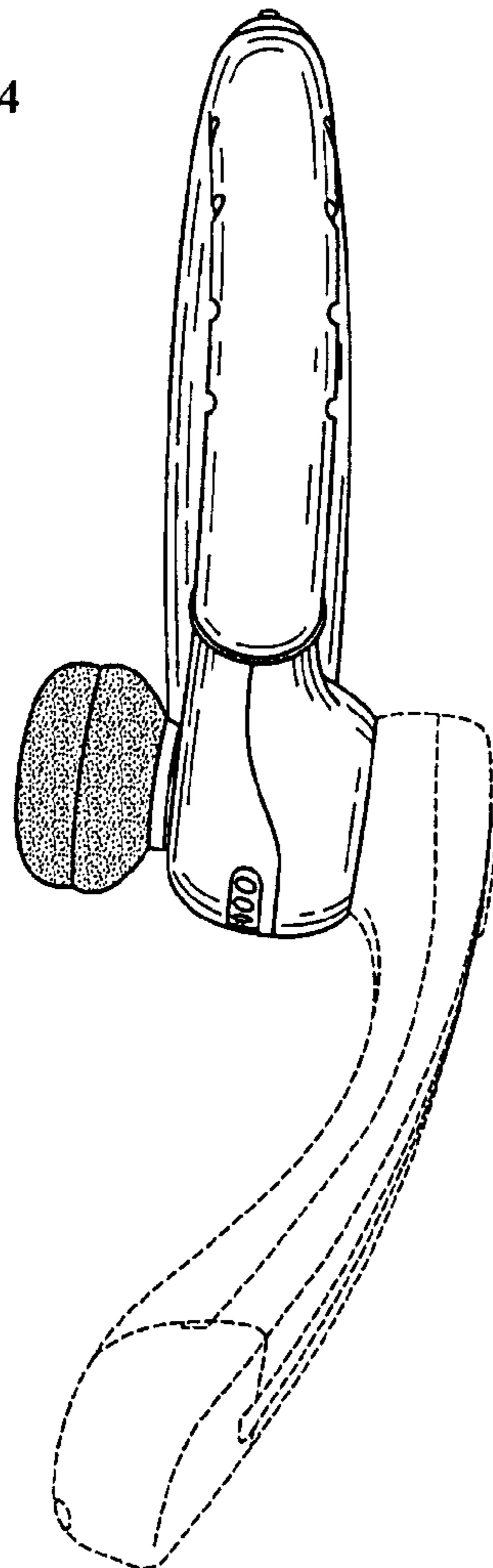


FIG. 6

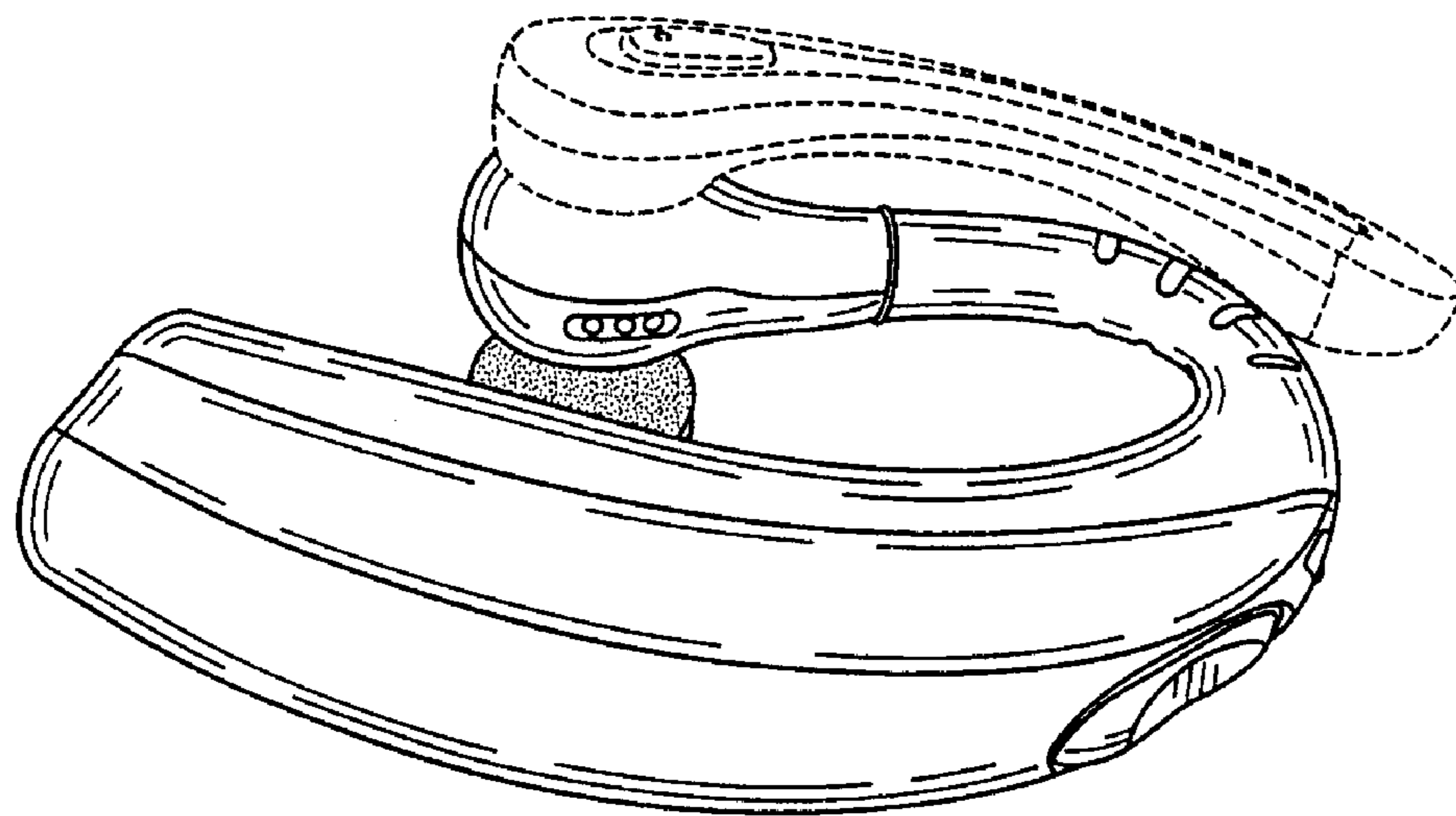


FIG. 7